

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

	:	Examiner:	S.J. Cohen
Hans-Jurgen Albrecht, et al.)		
	:	Group Art No.:	1793
Application No.: 10/554,274)		
	:	Confirmation No.:	3094
Filed: September 13, 2006)		
	:		
For: SOLDERING MATERIAL BASED ON Sn)			
Ag AND Cu	:	July 1, 2011	

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed February 1, 2011, the due date for which having been extended for a period of time of two (2) months up to and through July 1, 2011 by the accompanying Petition Under 37 C.F.R. § 1.136(a) and fee, kindly amend the subject application as follows:

Amendment to the claims begins on page 2 of this paper.

Remarks begin on page 3 of this paper.